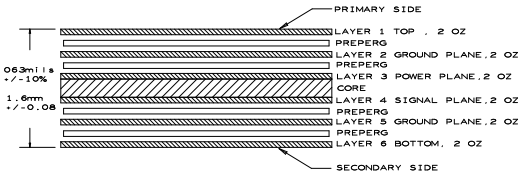
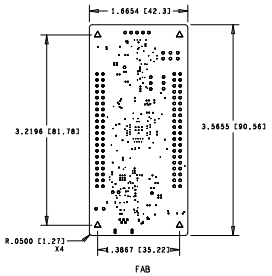
REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
1	INITIAL RELEASE	04/11/15	RAJA
2	ALPHA RELEASE	01/12/15	RAJA
3	BETA RELEASE	22/12/15	RAJA





DRILL CHART: TOP to BOTTOM				
ALL UNITS ARE IN MILLIMETERS				
FIGURE	SIZE	TOLERANCE	PLATED	QTY
·	0.2032	+0.0762/-0.0762	PLATED	121
·	0.254	+0.0/-0.254	PLATED	16
·	0.254	+0.0762/-0.0762	PLATED	108
·	0.381	+0.0762/-0.0762	PLATED	18
*	0.7112	+0.0762/-0.0762	PLATED	5
⊙	1.016	+0.0762/-0.0762	PLATED	103
△	3.175	+0.0508/-0.0508	NON-PLATED	4
▯	1.8999x0.701	+0.0762/-0.0762	PLATED	2

NOTES:(UNLESS OTHERWISE SPECIFIED)

1. RoHS COMPLIANT CERTIFICATION OR MATERIAL DECLARATION REQUIRED.
2. MATERIAL:
   A. IS410 OR EQUIVALENT. MATERIAL MUST CONFORM TO UL94V-0.
   B. USE HTE COPPER, AS SPECIFIED IN THE CROSS SECTION DIAGRAM.
   C. OVERALL METAL TO METAL THICKNESS AS SPECIFIED IN THE CROSS SECTION.
3. DRILLING:
   A. DIAMETERS IN DRILL TABLE ARE FINISHED HOLE SIZES +/-.003 tol. UNLESS OTHERWISE SPECIFIED IN DRILL TABLE.
   B. TEARDROP ALLOWED ON ENTRY OF VIA ON EVERY TRACE LAYER.
4. PLATING:
   COPPER PLATING IN THRU-HOLES .001 min.
5. MARKING:
   A. SILKSCREEN IN WHITE NON-CONDUCTIVE EPOXY INK ON PRIMARY SIDE OF THE BOARD OR BOTH SIDES IF APPLICABLE.
   B. FABRICATOR TO PLACE DATE CODE, LOGO AND RoHS COMPILANT SYMBOL IN SILKSCREEN ON SECONDARY SIDE.
6. FINAL FABRICATION:
   A. SOLDRMASK PRIMARY AND SECONDARY SIDE OF BOARD USING LIQUID PHOTOIMAGABLE MASK MATERIAL OVER BARE COPPER. PER IPC-SM-840. MASK ARTWORKS PROVIDED ARE 1:1. SOLDERMASK COLOR **BLUE**
7. FINISH:
   A. SHALL BE ELECTROLESS NIKEL & IMMERSION GOLD(ENIG).
   B. NICKEL THICKNESS: 100-200 MICROINCHES.
   C. GOLD THICKNESS: 3-10 MICROINCHES.
8. BOARDS SHALL BE PURCHASED FROM UL RECOGNIZED VENDORS ONLY. FLAMABILITY RATING (94-V0).
9. MANUFACTURE BOARD TO BE IN ACCORDANCE WITH PERFORMANCE STANDARD IPC-6011/6012 CLASS 2 BOARD TO BE INSPECTED PER IPC-600-A CLASS 2.
10. MAXIMUM WARP OR TWIST SHALL NOT EXCEED .007 in/in.
11. TESTING:
   A. FABRICATOR TO ADD TEST STRUCTURES OR CUPONS AS NEEDED.
   B. T-LINE IMPEDENCE TO BE TESTED OR GUARANTEE WITHIN 10% IF SPECIFIED IN THE CROSS SECTION. TOLERANCE TO BE +/-10% UNLESS OTHERWISE SPECIFIED.

UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN INCHES
TOLERANCES ON: ANGLES +/- 2°
2 PL DECIMALS +/- .010
3 PL DECIMALS +/- .005
THIRD ANGLE PROJECTIONS

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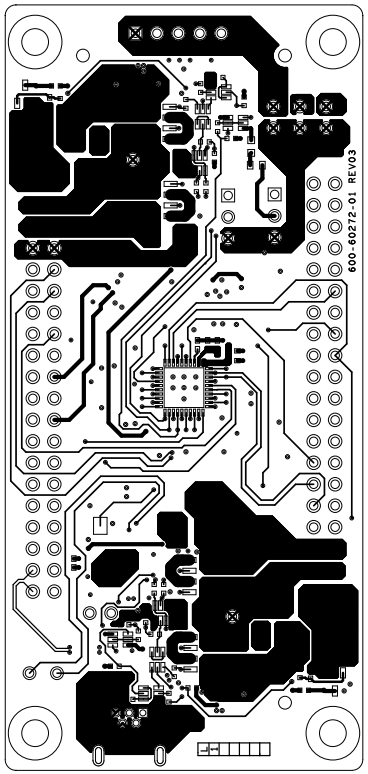
SIGNATURES		DATE
DRAWN :	HUSAIN	22/12/15
CHECKED :	RAJA	22/12/15
ENGRG :	RAGO	22/12/15
ISSUED		

CYPRESS SEMICONDUCTOR
198 CHAMPION COURT
SAN JOSE, CA 95134
(408) 943-2600

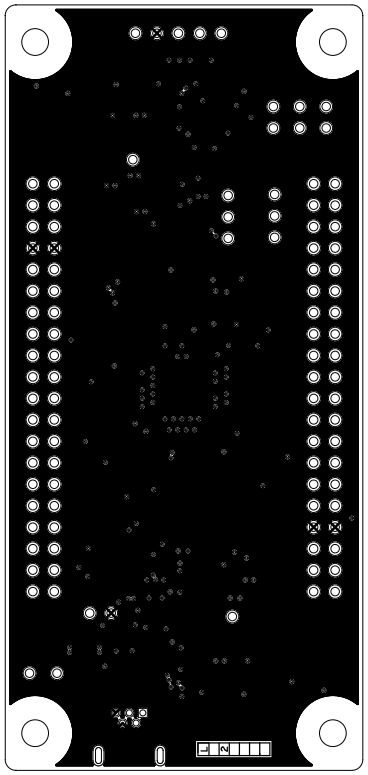
FABRICATION DRAWING
CY4541 CCG4 DAUGHTER CARD

SIZE	FSCM NO	DWG NO	REV
C		610-60276-01	03

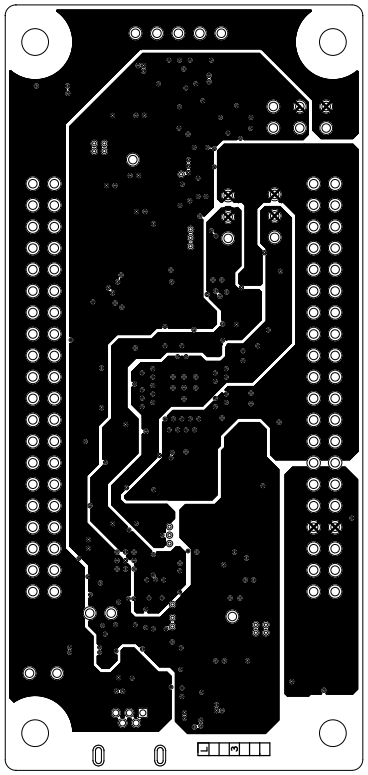
SCALE: 1/1 SHEET: 1 OF 1



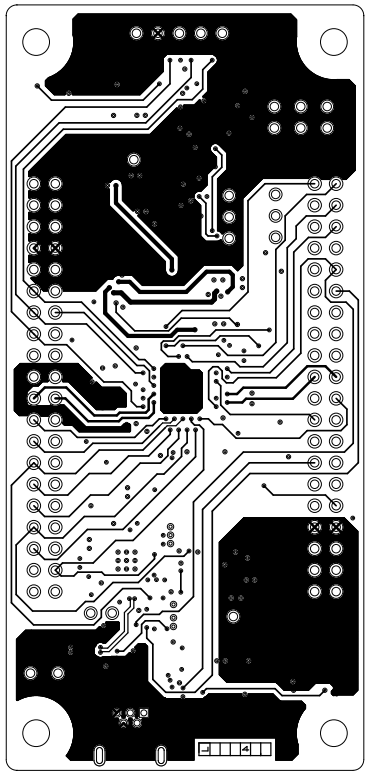
600-60272-01 REV03 PRIMARY SIDE



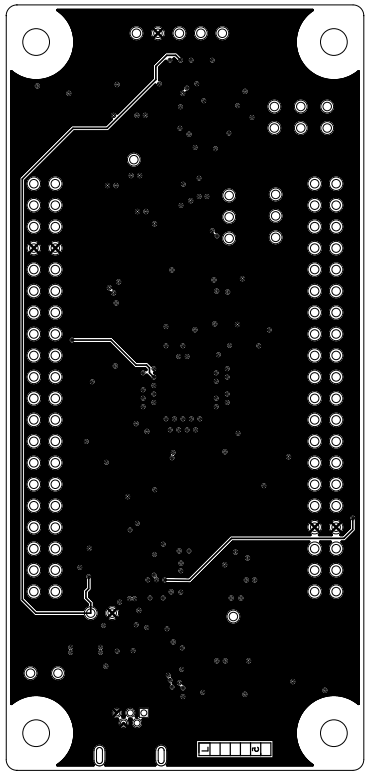
600-60272-01 REV03 GROUND1 LAYER



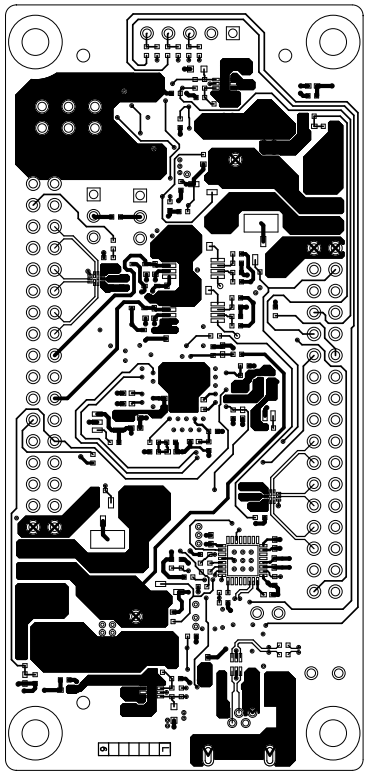
600-60272-01 REV03 POWER1 LAYER



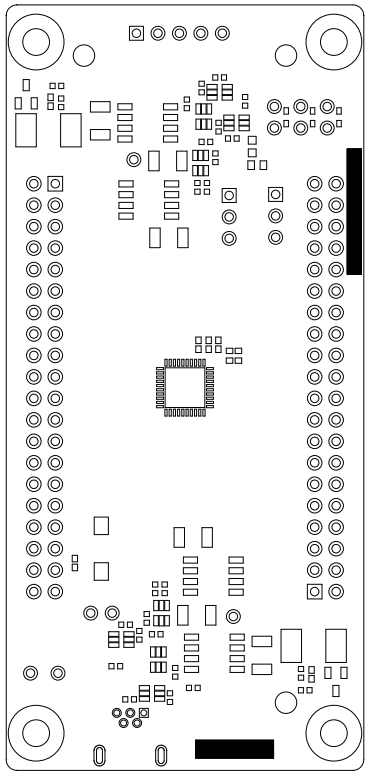
600-60272-01 REV03 SIGNAL1 LAYER



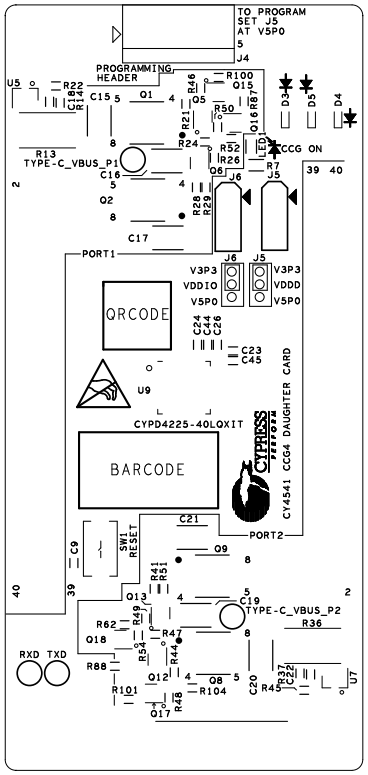
600-60272-01 REV03 GROUND2 LAYER



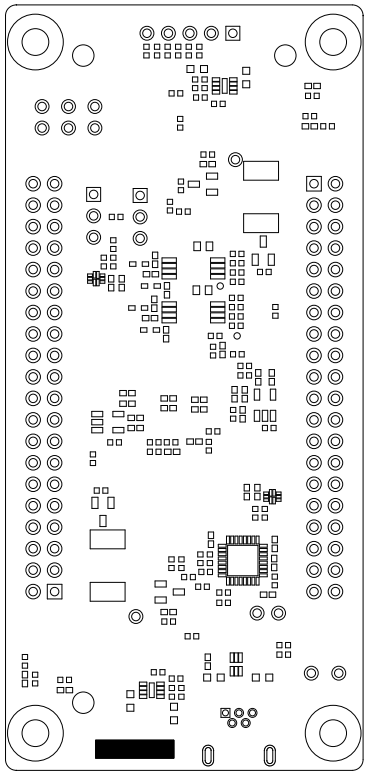
600-60272-01 REV03 SECONDARY SIDE



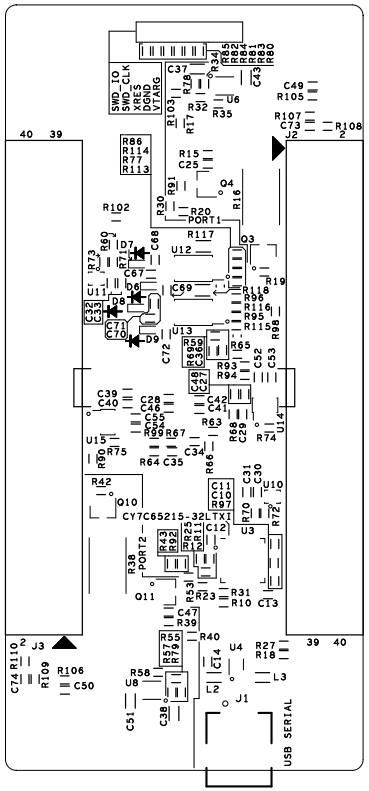
600-60272-01 REV03 PRIMARY SOLDERMASK



600-60272-01 REV03 PRIMARY SILKSCREEN



600-60272-01 REV03 SECONDARY SOLDER MASK



600-60272-01 REV03 SECONDARY SILKSCREEN